# BUILDING DESCRIPTION OF THE 144 MHz HIGH IIP3 LNA, by P.C. Hoefsloot, PA3BIY

Email: pa3biy@wanadoo.nl

This description contains the following parts:

- 1. Building procedures;
- 2. Test and Tune;
- 3. Casing and Moisture considerations;
- 4. Component listing;
- 5. Schematic;
- 6. PCB layout.

#### 1. BUILDING PROCEDURES

The 144 MHz Low Noise Amplifier is a single E-Phemt amplifier, utilising Surface Mount Devices (SMD). The amplifier can be build by non-experts, as long as some rules are taken into account:

- Non-static environment;
- Grounding of solder iron and work bench;
- Clean solder tip;
- Good solder quality.

The active device (ATF-54143) is very sensitive to static voltages, so every measure must be taken in order to prevent premature loss.

A proper solder contact is somewhat hollow, and it "shines" (see figure 1). If you have used too much solder, remove it using the solder wick that is supplied.

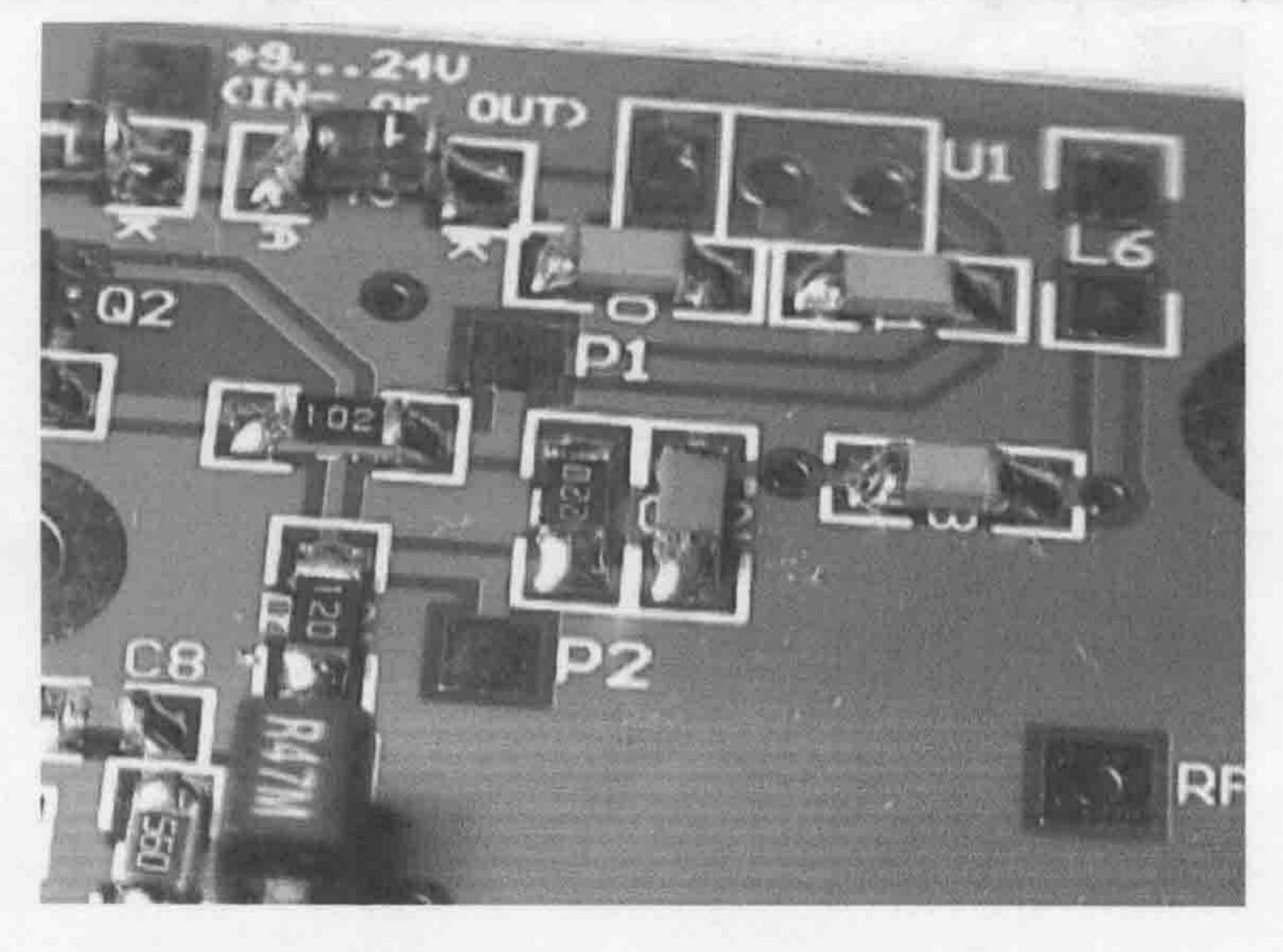


Figure 1: Shiny contacts!

## Coaxial relay switching and feeding the pre-amp

The pre-amp can be fed in 2 ways: using the centre conductor of the RX feedline, or the external feed on the capacitor feed-through.

when you use the coax for feeding the LNA and driving the coax relay, make sure that the relay surges less than 400 mA, as the SMD inductors (L6 and L7) are current limited. Diodes D1 and D2 protect the LNA against mis-polarisation and from negative surges from the coax relay, at switch off.

#### (Non-) Static environment

A static environment is easily demonstrated. When one pulls out a woollen vest, you will see sparks igniting in the dark. The voltages involved can amount to several thousands of Volts: Deadly to any semiconductor. However, even a chair and some synthetic or Woollen material that one wears, may set a high voltage potential to oneself. The voltage may be too low to ignite large sparks when touching earth, but enough to kill an active device.

#### **Preventing Static**

- 1. Don't wear woollen clothing;
- Don't rub your back against the (synthetic!) rug of the chair, because you will be charging yourself!
- Make sure that there is a proper earth on your work bench, and touch it before you
  touch any components, in order to make sure that all charge flows to ground;
- 4. Earth the solder Iron. You can do this by clamping a wire, with a 10....100 kOhm resistor in series, between Ground and the metal of the solder Iron. The series resistor makes sure that no charge can build on the solder Iron, and it will prevent high short circuit currents if you happen to touch a life voltage contact.

#### **Building procedure**

Use a solder iron with 2 kind of tips (or 2 different solder irons). One tip needs to be tiny and sharp, and is needed to solder the SMD components. The other must be sturdy tip, and is needed to solder the tuning capacitor (C2), the input coil (L1) and the coupling inductor between C2 and the FET (L2). Figure 2 shows how the series circuit of R13 and C3 is connected across L2 (This may be omitted, as the LNA is stable without it).



Figure 2: R13 and C3 across L2

The building is not very critical for most of the parts. Just make sure that Q1 (the E-Phemi ATF-54143) is soldered in as one-but-last of the components!

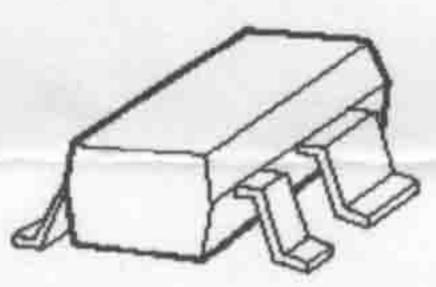
- Solder all resistors, capacitors, diodes, inductors and Q2 (except Q1 and U1). Use the fine tip;
- 2. Solder C2, L1 and L2. Use the sturdy tip;
- Solder C5 "head up" and attach it to C2, using a short piece of wire. Use the sturdy tip;
- 4. Place the series circuit of R13 and C3 across L2 (figure 2). Use the fine tip;
- 5. Make sure that all is grounded, and solder Q1 into the circuit, using the fine tip;
- 6. Place the PCB in the Aluminium milled box and attach it to the bottom with 5 M3 type screws. Next, bend the wires of U1 into the right shape and adjust the length. Fix the regulator (U1) to the side of the box with an M3 type screw and only then solder U1 at the PCB.

C1 is a lead-less very high Q capacitor and needs to be connected between the centre tip of the input N-connector and C5/C2. Use the supplied 0.8mm silvered copper wire for this purpose.

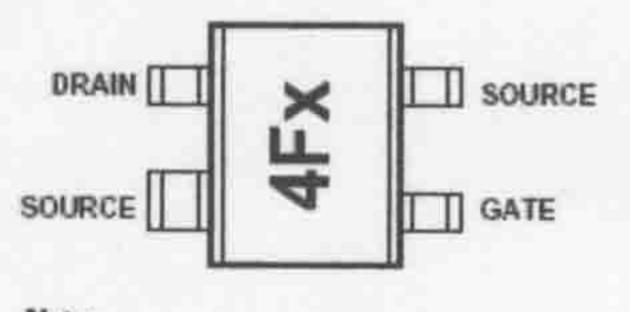
The output can be connected using a short (!) wire between "RF OUT" and the centre pin of the output N-connector.

Finally, the Feed-through capacitor must be connected to "+9...24V In-or-Out" (may be used as output for coax relay, when power is supplied through the output coax). MAX DC = 20V!

#### Surface Mount Package SOT-343



#### Pin Connections and Package Marking



Note:

Top View. Package marking provides orientation and identification

"4F" = Device Code

"x" = Date code character identifies month of manufacture.

Figure 3

ATF-54143 Absolute Maximum Ratings [1]

Symbol	Parameter	Units	Abso
V <sub>DS</sub>	Drain - Source Voltage [2]	V	5
V <sub>GS</sub>	Gate - Source Voltage[2]	V	-5 to 1
V <sub>GD</sub>	Gate Drain Voltage [2]	ν	5
Ins	Drain Current [2]	mA	120
P <sub>diss</sub>	Total Power Dissipation [3]	mW	360
P <sub>in max</sub>	RF Input Power	dBm	10[5]
GS	Gate Source Current	mA	2[5]
Тан	Channel Temperature	°C	150
T <sub>STE</sub>	Storage Temperature	°C	-65 to
$\Theta_{jc}$	Thermal Resistance <sup>[4]</sup>	°C/W	162

Table 1

## 2. TESTING AND TUNING THE LNA

On the PCB 2 test points are available: P1 and P2. These points can be used to measure the current that actually flows through the transistor. The voltage across R6 should amount about 1.4 V, hence a current of approximately 63 mA flows through the FET.

luning to minimum noise figure is rather straight forward: close the lid of the aluminium box look for a stable signal on 2 metre, and tune for maximum gain using C2.

Opening and closing the lid, should only see a marginal change in gain. No change in supply current must be observed! If you do find a change in current between opening and closing the lid, check if the series circuit of R13 and C3 is in good order.

The LNA is ready for use!

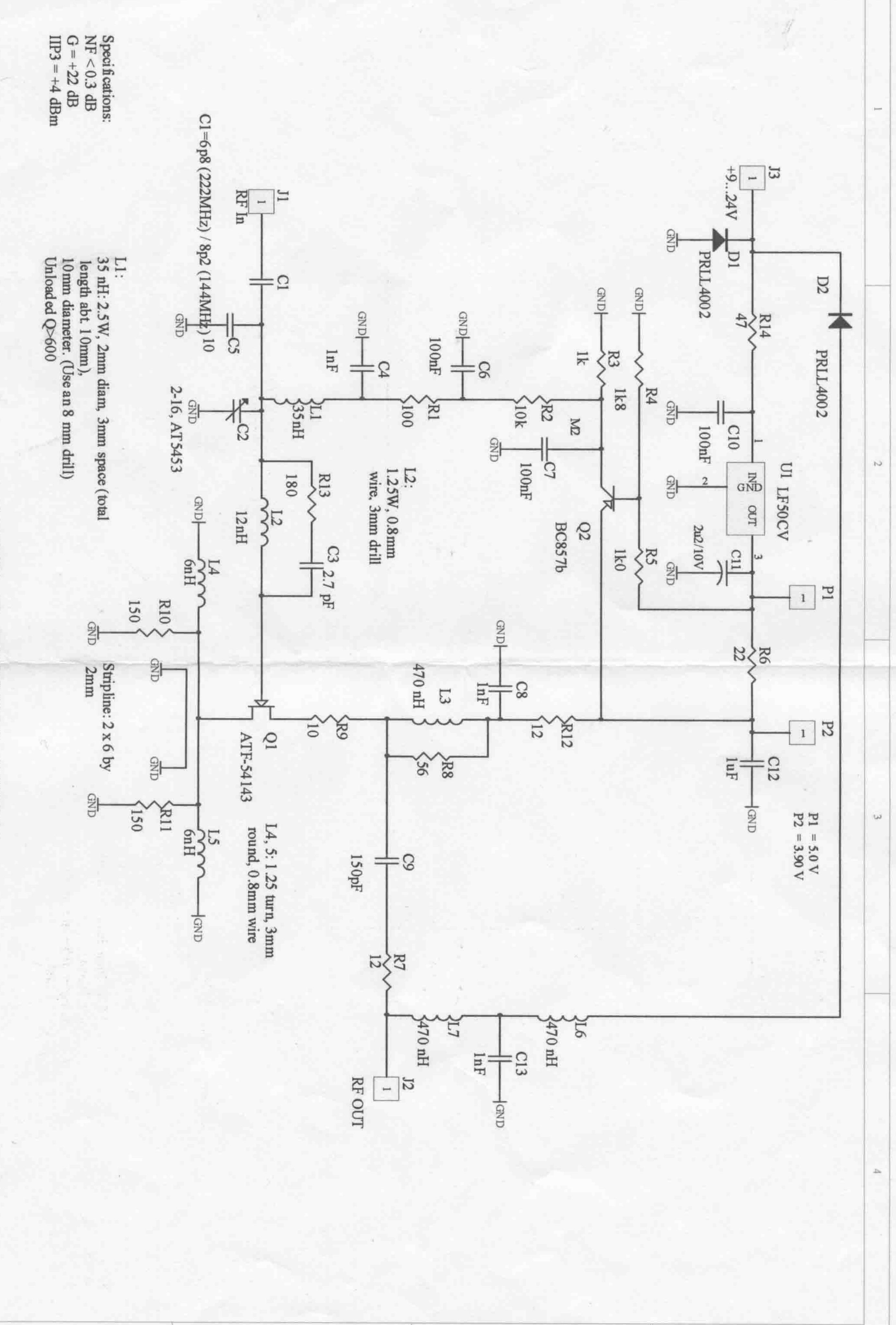
#### 3. CASING AND MOISTURE CONSIDERATIONS

Moisture can destroy electronic circuitry in the long run. There are several ways to prevent moisture doing harm to an electronic system.

- Keep the box into open contact with the atmosphere, so any moisture can breath in and out;
- 2. Air-tighten the box, so no moisture can get in (or out);
- Spray a protecting film over the components, preventing moisture (and salt) to reach them.

The supplied N-connectors are fairly moist proof and air-tight. Preventing moist and salt to reach the inner circuitry can be improved by adding some silicon gel to the connector base plates, and to wrap vulcanising tape around the connectors.

It is extremely difficult to insure for 100% that no moist will ever get in a box! A change of outside temperatures will cause the air inside to shrink or to expand. As a result outside air might be sucked in or pushed out.



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144 MHz High IP3 LNA by PA3BIY

15